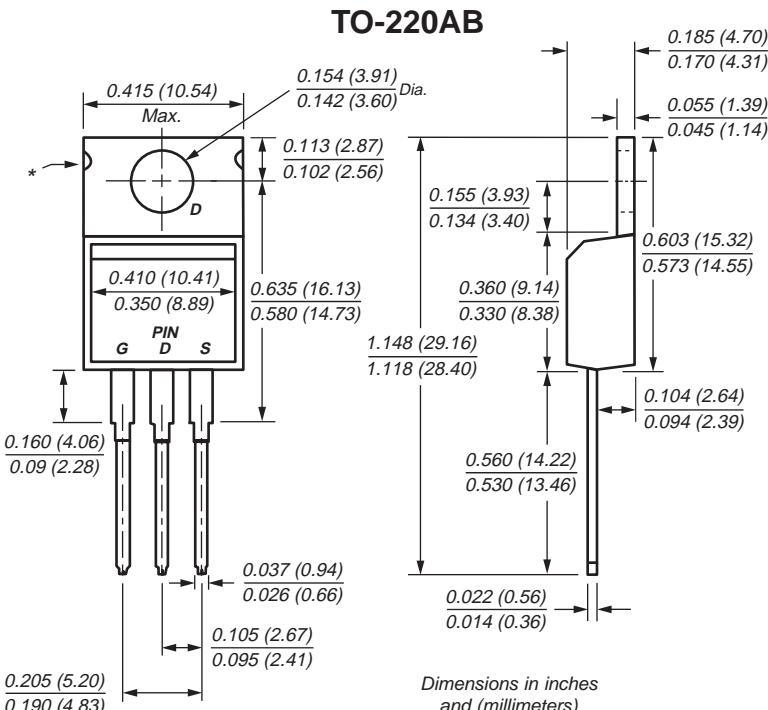


# N-Channel Enhancement-Mode MOSFET

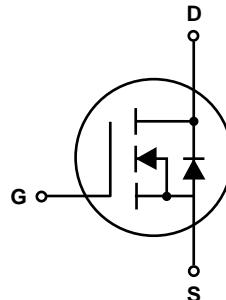
**V<sub>DS</sub>** 30V   **R<sub>DSON</sub>** 6.5mΩ   **I<sub>D</sub>** 80A

# TRENCH GENFET®

## New Product



\* May be notched or flat



## Features

- Advanced Process Technology
  - High Density Cell Design for Ultra Low On-Resistance
  - Specially Designed for Low Voltage DC/DC Converters
  - Fast Switching for High Efficiency

## Mechanical Data

**Case:** JEDEC TO-220AB molded plastic body

**Terminals:** Leads solderable per MIL-STD-750, Method 2026

**High temperature soldering guaranteed:**  
250°C/10 seconds. 0.17" (4.3mm) from case

**Mounting Torque:** 10 in-lbs maximum

**Weight:** 20g

## Maximum Ratings and Thermal Characteristics ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	
Continuous Drain Current <sup>(1)</sup>	I <sub>D</sub>	80	A
Pulsed Drain Current	I <sub>DM</sub>	240	
Maximum Power Dissipation T <sub>A</sub> = 25°C T <sub>A</sub> = 100°C	P <sub>D</sub>	69.4 27.8	W
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C
Lead Temperature (1/8" from case for 5 sec.)	T <sub>L</sub>	275	°C
Junction-to-Case Thermal Resistance	R <sub>θJC</sub>	1.8	°C/W
Junction-to-Ambient Thermal Resistance	R <sub>θJA</sub>	62.5	°C/W

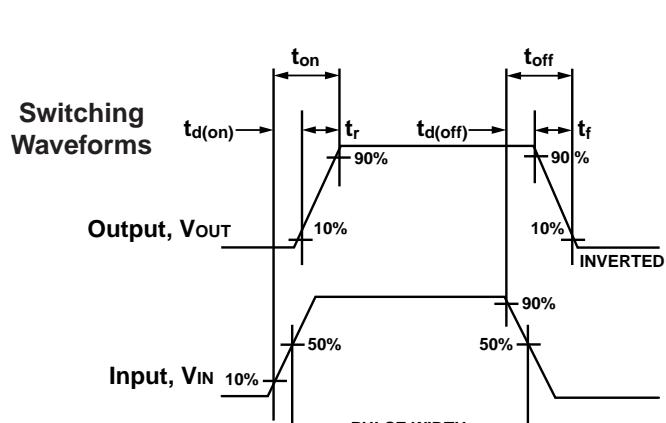
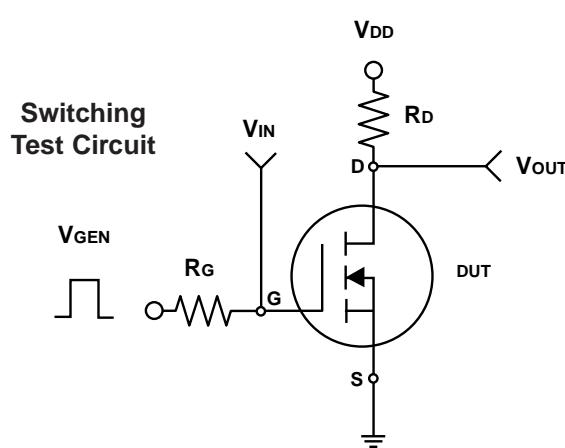
**Note:** (1) Maximum DC current limited by the package

**N-Channel Enhancement-Mode MOSFET**
**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_D = 250\mu\text{A}$	30	—	—	V
Drain-Source On-State Resistance <sup>(2)</sup>	$\text{R}_{\text{DS}(\text{on})}$	$\text{V}_{\text{GS}} = 10\text{V}, \text{I}_D = 38\text{A}$	—	5.8	6.5	$\text{m}\Omega$
		$\text{V}_{\text{GS}} = 4.5\text{V}, \text{I}_D = 31\text{A}$	—	8.5	9.5	
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}, \text{I}_D = 250\mu\text{A}$	1.0	—	3.0	V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}} = 30\text{V}, \text{V}_{\text{GS}} = 0\text{V}$	—	—	1.0	$\mu\text{A}$
Gate-Body Leakage	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}} = \pm 20\text{V}, \text{V}_{\text{DS}} = 0\text{V}$	—	—	$\pm 100$	nA
On-State Drain Current <sup>(2)</sup>	$\text{I}_{\text{D}(\text{on})}$	$\text{V}_{\text{DS}} \geq 5\text{V}, \text{V}_{\text{GS}} = 10\text{V}$	75	—	—	A
Forward Transconductance <sup>(2)</sup>	$\text{g}_{\text{fs}}$	$\text{V}_{\text{DS}} = 15\text{V}, \text{I}_D = 38\text{A}$	—	61	—	S
<b>Dynamic</b>						
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=15\text{V}, \text{V}_{\text{GS}}=5\text{V}, \text{I}_D=38\text{A}$	—	32.5	46	nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$		—	63	90	
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		—	11	—	
Turn-On Delay Time	$\text{t}_{\text{d}(\text{on})}$		—	13	26	
Turn-On Rise Time	$\text{t}_r$	$\text{V}_{\text{DD}} = 15\text{V}, \text{V}_{\text{GS}} = 10\text{V}$ $\text{I}_D \approx 1\text{A}, \text{V}_{\text{GEN}} = 10\text{V}$ $\text{R}_G = 6\Omega$	—	16	29	ns
Turn-Off Delay Time	$\text{t}_{\text{d}(\text{off})}$		—	94	132	
Turn-Off Fall Time	$\text{t}_f$		—	38	57	
Input Capacitance	$\text{C}_{\text{iss}}$		—	3240	—	pF
Output Capacitance	$\text{C}_{\text{oss}}$	$\text{V}_{\text{DS}} = 15\text{V}, \text{V}_{\text{GS}} = 0\text{V}$ $f = 1.0\text{MHz}$	—	625	—	
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		—	285	—	
<b>Source-Drain Diode</b>						
Max. Diode Forward Current	$\text{I}_s$	—	—	—	75	A
Diode Forward Voltage	$\text{V}_{\text{SD}}$	$\text{I}_s = 38\text{A}, \text{V}_{\text{GS}} = 0\text{V}$	—	0.9	1.3	V

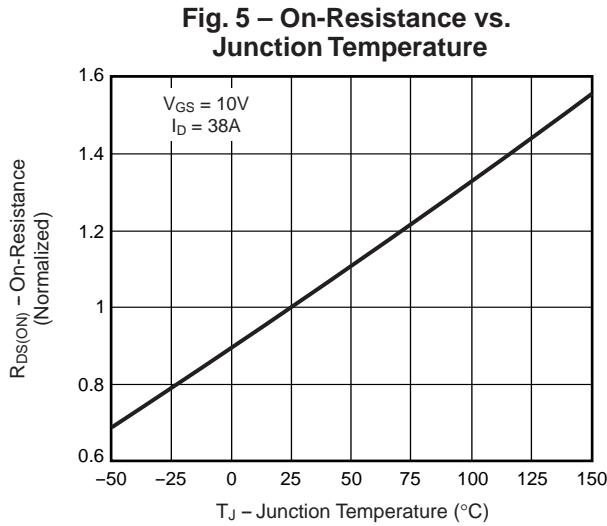
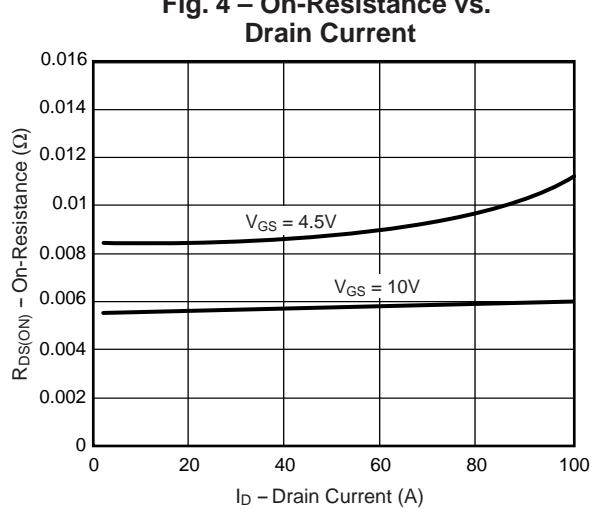
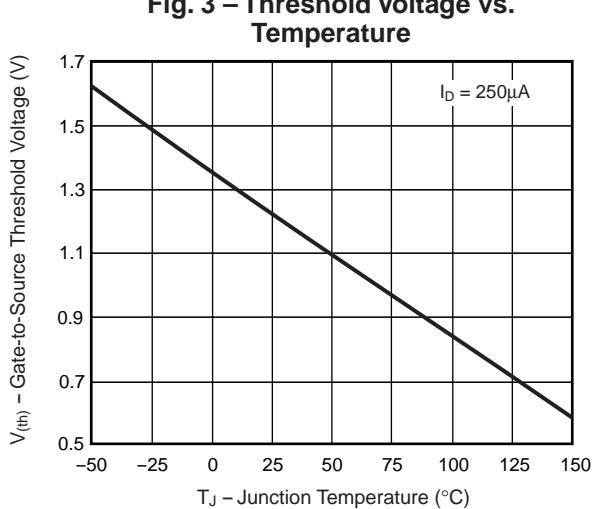
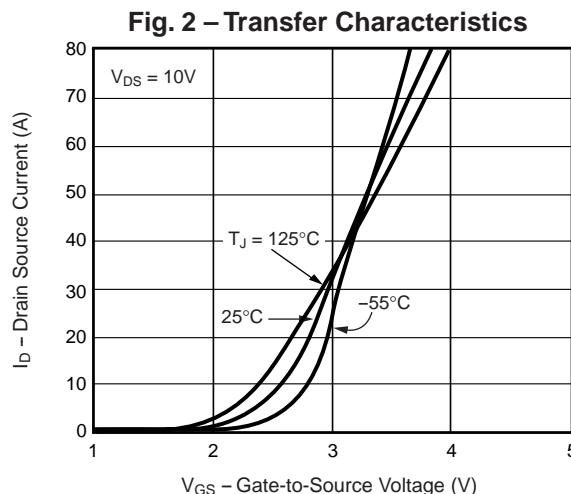
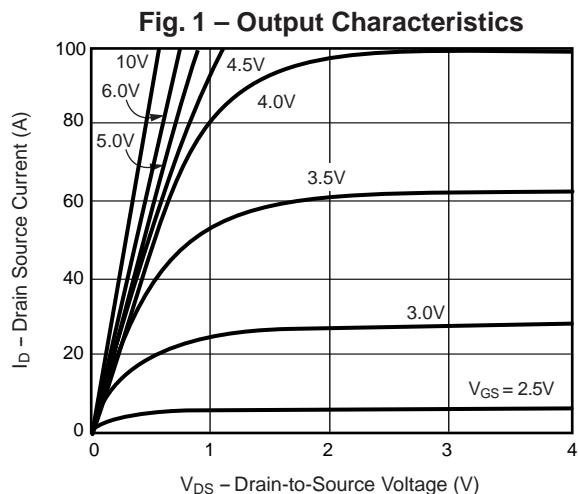
**Note:**

(1) Pulse test; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$



## N-Channel Enhancement-Mode MOSFET

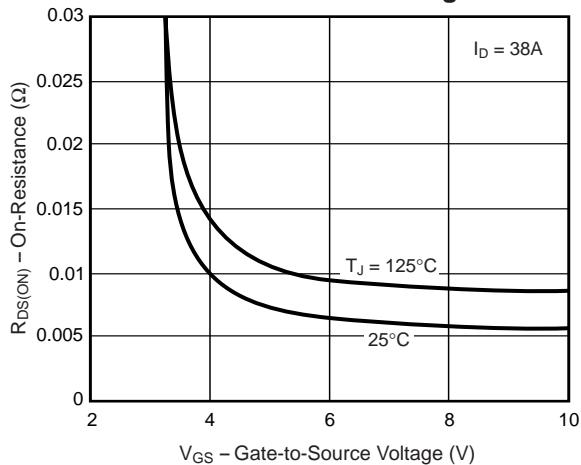
### Ratings and Characteristic Curves (TA = 25°C unless otherwise noted)



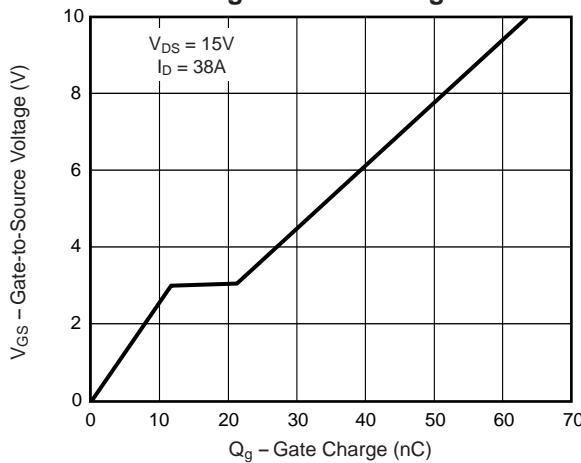
# N-Channel Enhancement-Mode MOSFET

## Ratings and Characteristic Curves ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

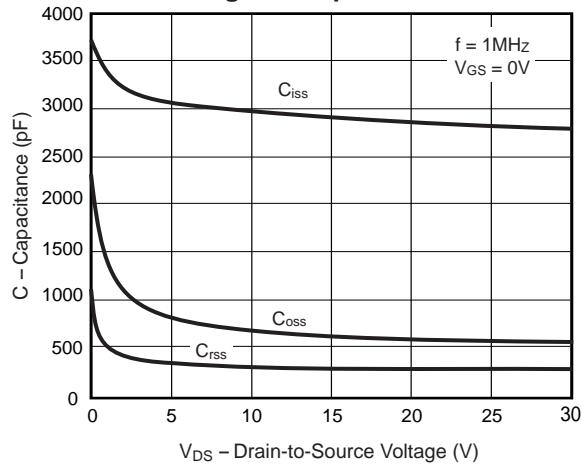
**Fig. 6 – On-Resistance vs. Gate-to-Source Voltage**



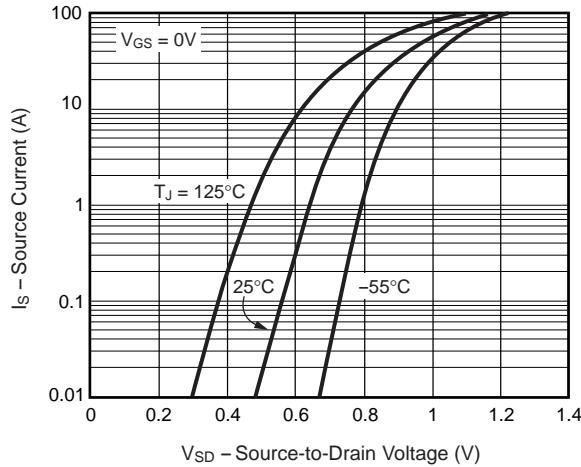
**Fig. 7 – Gate Charge**



**Fig. 8 – Capacitance**



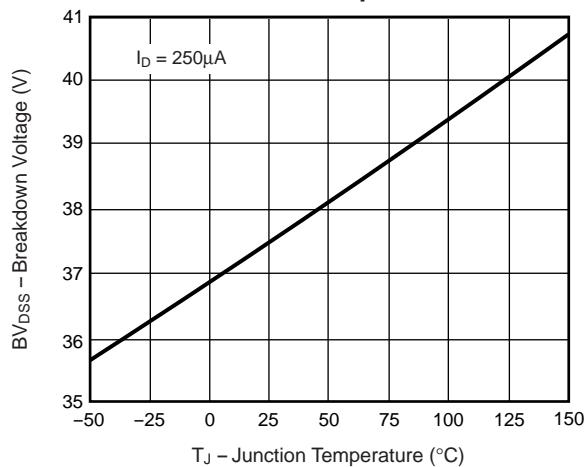
**Fig. 9 – Source-Drain Diode Forward Voltage**



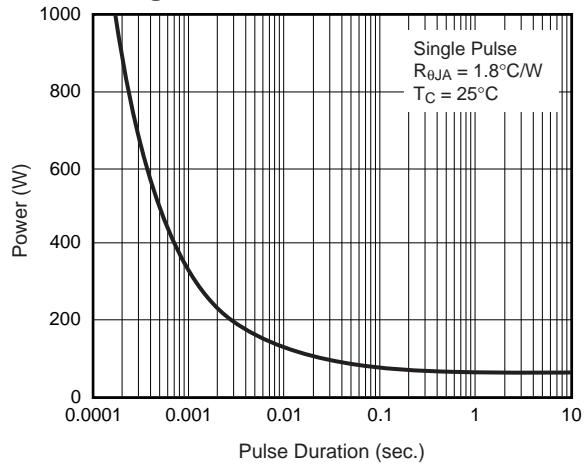
## N-Channel Enhancement-Mode MOSFET

### Ratings and Characteristic Curves ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

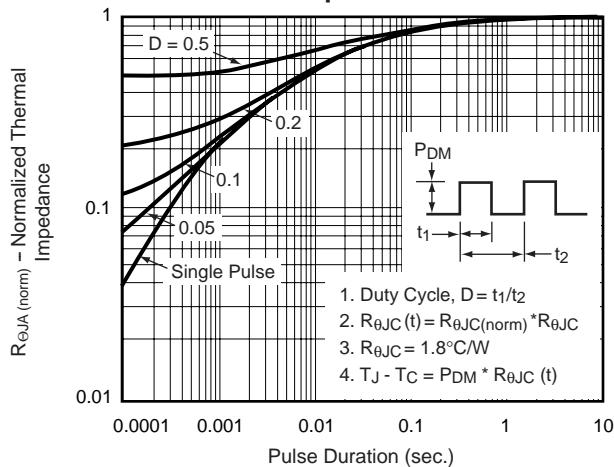
**Fig. 10 – Breakdown Voltage vs. Junction Temperature**



**Fig. 12 – Power vs. Pulse Duration**



**Fig. 11 – Transient Thermal Impedance**



**Fig. 13 – Maximum Safe Operating Area**

